

Proforma

Companies open to your department

Company : Taiwan Semiconductor Manufacturing Company
Company Name : Taiwan Semiconductor Manufacturing Company
Nature Of Business : Semiconductor
Designation : Software and Data Engineer
Tentative Job Location : Hsinchu City, Taiwan

Responsibilities

- 1. Development and integration of Cloud Computing, Kubernetes or BigData Analytics Systems
- 2. Build/Development Scalable Platform for managing container applications
- 3. Development utilities and applications for IT operation automation.

Requirements

- Description :
- 1. Master degree of Computer Science, Information Management or Electrical Engineering.
 - 2. Familiar with development of C/C++ or JAVA Programming, or
 - 3. Familiar with Microservices Architecture Pattern, DevOps or
 - 4. Familiar with Web Applications for PC and Mobiles, or
 - 5. Familiar with Hadoop, Spark and Parallel Computing.
 - 6. The ones with multiple above skill sets and experience will be a plus.
 - 7. Experience with large-scale system integration, cloud computing, social networking for factory automation will be a plus
 - 8. Self-motivated, integrity, aggressive and result-oriented personality.

Department		BT	BS	MT	Double	Major	dual	dual	B	dual	C	Mdes	MBA	Phd	MSc	MSR
Eligibility :	AE	N	-	N	N		N	N	N	-	-	N	-	N		
	BSBE	N	-	N	N		N	N	N	-	-	N	-	N		
	CE	N	-	N	N		N	N	N	-	-	N	-	N		
	CHE	N	-	N	N		N	N	N	-	-	N	-	N		
	CSE	N	-	Y	N		Y	Y	Y	-	-	N	-	Y		
	EE	N	-	Y	N		Y	Y	Y	-	-	N	-	Y		
	ES	-	N	N	-		N	-	N	-	-	N	-	-		
	ME	N	-	N	N		N	N	N	-	-	N	-	N		
	MSE	N	-	Y	N		Y	Y	Y	-	-	N	-	Y		
	PHY	-	N	-	N		N	N	N	-	-	N	N	-		
	CHM	-	N	-	N		N	N	N	-	-	N	N	-		
	MTH	-	N	-	N		Y	Y	Y	-	-	N	Y	-		
	ECO	-	N	-	N		N	N	N	-	-	N	-	-		
	DES	-	-	-	-		-	-	N	N	-	N	-	-		
	IME	-	-	Y	-		-	Y	Y	-	N	N	-	-		
	CGS	-	-	-	-		-	-	-	-	-	N	-	N		
	HSS	-	-	-	-		-	-	-	-	-	N	-	-		
	EEM	-	-	N	-		-	N	-	-	-	N	-	-		
	MSP	-	-	Y	-		-	-	-	-	-	N	-	-		
	NET	-	-	N	-		-	N	-	-	-	N	-	-		
	PSE	-	-	Y	-		-	Y	-	-	-	N	-	Y		
	Stats	-	-	-	-		-	-	-	-	-	N	Y	-		

Item (Annual)	Master Degree
GROSS	\$ 48,533
CTC	\$ 51,566

Currency: USD

- Package Details :
- 1. Including 12 months base pay, 2 months Year-end bonus, 18 months Profit Sharing, 2 months relocation bonus, months of sign on bonus (depends on whether the offer has bond).
 - 2. Base Salary, Year-end bonus are fixed and recurring ; Profit Sharing is minimum amount for an average performance (i.e. top 50%) and recurring. ; Relocation and sign on bonus are one shot paid after onboard.
 - 3. Please note that the "Bond duration" is just for reference. The actual duration will depend on the offer that you get, it would be determined by your hiring manager.

Bond : True

Bond Details :	May have bond but it depends on further hiring assessment. (will be determined by the hiring manager)
Medical Requirements :	
Resume Shortlist :	True
Resume Shortlist Criteria:	None
Aptitude Test:	False
Group Discussion:	False
Technical Test:	False
Technical Interview:	True
Technical Interview Duration:	60 min
Number of Techincal Interview Rounds:	1
HR Interview:	True
HR Interview Duration:	60 min
